## AMENDMENTS TO THE CLAIMS:

Please amend Claims 1, 10, 18, and 29 as follows:

1. (Currently amended) A method of coating free-standing micromechanical devices, the method comprising:

> depositing an organic resin coating material on said micromechanical device in sufficient quantity to substantially encapsulate prevent movement of said micromechanical device, said coating material comprised of at least 35% solids in a solvent, said coating material having a viscosity no greater than 120 centistokes; and curing said coating material.

- 2. (Original) The method of Claim 1, said depositing comprising depositing a coating material having a viscosity of 118 centistokes.
- (Original) The method of Claim 1, said depositing comprising depositing a coating 3. material having a surfactant.
- (Original) The method of Claim 1, said depositing comprising depositing said coating 4. material in a layer thick enough to cover structures on said micromechanical device after the removal of said solvent.
- 5. (Original) The method of Claim 1, comprising: rotating said micromechanical device to distribute said organic coating material.
- 6. (Original) The method of Claim 1, comprising: rotating said micromechanical device at 3000 rpm to distribute said organic coating material.
- 7. (Original) The method of Claim 1, said curing comprising: heating said micromechanical device.
- (Original) The method of Claim 1, said curing comprising: 8. heating said micromechanical device at 100° C.
- 9. (Original) The method of Claim 1, said curing comprising:

heating said micromechanical device to a first elevated temperature to remove a majority of said solvent, and then lowering said temperature to remove additional solvent,

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